

10-15-01

BOX NEW APPLICATION
COMMISSIONER OF PATENTS AND TRADEMARKS
WASHINGTON, D.C. 20231

A

Attorney Docket No. P-3641.163

NEW APPLICATION TRANSMITTAL

Transmitted herewith for filing is the new patent application of

Inventors: Cheng-Ho HSU, Yi-Hua CHANG, and Jen-Cheng LIU
For: SEMICONDUCTOR PACKAGING STRUCTURE

Enclosed are:

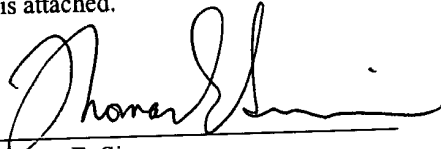
- [x] 14 Pages of specification, claims and abstract.
[x] 8 Sheets of drawings.
[x] An Assignment (with cover sheet) of the invention to Taiwan IC Packaging Corporation
[] A certified copy of a _____ application.
[x] Applicant claims small entity status (form enclosed).
[x] Declaration and Power of Attorney For Patent Application.
[x] Power of Attorney.
[] Non-publication request form.
[] Information Disclosure Statement By Applicant (with Form PTO-1449).
[x] Acknowledgment postcard.

The filing fee has been calculated as shown below:

	Number Filed	Number Extra	Small Entity		Other Than A Small Entity	
			Rate	Fee	Rate	Fee
Basic Fee				370.		740.
Total Claims	20-20=	0	X 9.		X18.	
Indep. Claims	17-3=	0	X42.		X84.	
Multiple Dependent Claim			140.		280.	
Total				370.		

Assignment 40.
410.

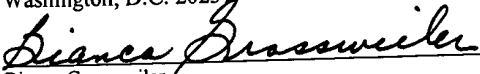
[X] A check in the amount of \$410 to cover the filing and assignment fees is enclosed. Any deficiency in fees should be charged to Account #07-2400. A duplicate of this transmittal is attached.


Thomas E. Sisson
Reg. No. 29,348
JACKSON WALKER L.L.P.
112 E. Pecan Street, Suite 2100
San Antonio, Texas 78205
(210) 978-7700

Express Mail label no. EL797497735US

Date of Deposit: 10-12-01

I hereby certify that this paper or fee is being deposited with the U.S. Postal Service, Express Mail Post Office to Addressee service, under 37 CFR 1.10 on the date indicated above and is addressed to the Commissioner of Patents and Trademarks, Washington, D.C. 20231


Bianca Grossweiler
3015565v1

BOX NEW APPLICATION
COMMISSIONER OF PATENTS AND TRADEMARKS
WASHINGTON, D.C. 20231

Attorney Docket No. P-3641.163

NEW APPLICATION TRANSMITTAL

Transmitted herewith for filing is the new patent application of

Inventors: Cheng-Ho HSU, Yi-Hua CHANG, and Jen-Cheng LIU
For: SEMICONDUCTOR PACKAGING STRUCTURE

Enclosed are:

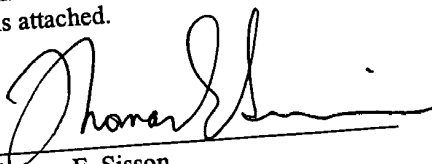
- ☒ 14 Pages of specification, claims and abstract.
- ☒ 8 Sheets of drawings.
- ☒ An Assignment (with cover sheet) of the invention to Taiwan IC Packaging Corporation
- ☐ A certified copy of a _____ application.
- ☒ Applicant claims small entity status (form enclosed).
- ☒ Declaration and Power of Attorney For Patent Application.
- ☒ Power of Attorney.
- ☐ Non-publication request form.
- ☐ Information Disclosure Statement By Applicant (with Form PTO-1449).
- ☒ Acknowledgment postcard.

The filing fee has been calculated as shown below:

	Number Filed	Number Extra	Small Entity		Other Than A Small Entity	
			Rate	Fee	Rate	Fee
Basic Fee				370.		740.
Total Claims	20-20=	0	X 9.		X18.	
Indep. Claims	17-3=	0	X42.		X84.	
Multiple Dependent Claim			140.		280.	
Total				370.		

Assignment 40.
410.


[X] A check in the amount of \$410 to cover the filing and assignment fees is enclosed. Any deficiency in fees should be charged to Account #07-2400. A duplicate of this transmittal is attached.



Thomas E. Sisson
Reg. No. 29,348
JACKSON WALKER L.L.P.
112 E. Pecan Street, Suite 2100
San Antonio, Texas 78205
(210) 978-7700

Express Mail label no. EL797497735US
Date of Deposit: 10-11-01 10-12-01

I hereby certify that this paper or fee is being deposited with the U.S. Postal Service, Express Mail Post Office to Addressee service, under 37 CFR 1.10 on the date indicated above and is addressed to the Commissioner of Patents and Trademarks, Washington, D.C. 20231.


Bianca Grossweiler
3015565v1